**MECHANICAL CASE OUTLINE**

**PACKAGE DIMENSIONS**

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**PQFN31 5X5, 0.5P**

**CASE 483BR**

**ISSUE D**

**DATE 13 FEB 2023**

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**For additional information on our Pb-Free strategy and soldering details, please download the ONSEM Soldering and Mounting Techniques Reference Manual.**

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**DOCUMENT NUMBER:** 98AON13680G

**DESCRIPTION:** PQFN31 5X5, 0.5P

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*This information is generic. Please refer to device data sheet for actual part marking. Pb–Free indicator, “G” or microdot “**”, may or may not be present. Some products may not follow the Generic Marking.*

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**GENERIC MARKING DIAGRAM**

- **XXXX** = Specific Device Code
- **A** = Assembly Location
- **WL** = Wafer Lot
- **YY** = Year
- **WW** = Work Week
- **/C0071** = Pb-Free Package

(Note: Microdot may be in either location)

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**MECHANICAL CASE OUTLINE**

**PACKAGE OUTLINE**

**RECOMMENDED MOUNTING FOOTPRINT**

(2X SCALE)

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